

## 3.1W Stereo Filter-Free Class-D Audio Amplifier

### 1 Description

The NAU8223 is a stereo high efficiency filter-free Class-D audio amplifier, which is capable of driving a 4Ω load with up to 3.1W output power. This device provides chip enable pin with extremely low standby current and fast start-up time of 3.4ms. It has five selectable gain settings (i.e. 0dB, 6dB, 12dB, 18dB and 24dB), which can be controlled by a single gain pin.

The NAU8223 is ideal for the portable applications of battery drive, as it has advanced features like 87dB PSRR, 91% efficiency, ultra low quiescent current (i.e. 2.1mA at 3.7V for 2 channels) and superior EMI performance. It has the ability to configure the inputs in either single-ended or differential mode.

NAU8223 is available in Miniature QFN-20 package.

#### Key Features

- Low Quiescent Current:
  - 2.1mA at 3.7V for 2 channels
  - 3.2mA at 5V for 2 channels
- 5 Selectable Gain Settings:
  - 0dB / 6dB / 12dB / 18dB / 24dB
- Powerful Stereo Class-D Amplifier:
  - 2ch x 3.1W (4Ω @ 5V, 10% THD+N)
  - 2ch x 1.26W (4Ω @ 3.7V, 1% THD+N)
  - 2ch x 1.76W (8Ω @ 5V, 10% THD+N)
  - 2ch x 0.76W (8Ω @ 3.7V, 1% THD+N)
- Low Output Noise: 20 μV<sub>RMS</sub> @0dB gain
- 87dB PSRR @217Hz
- Low Current Shutdown Mode
- Click-and Pop Suppression

#### Applications

- Notebooks / Tablet PCs
- Personal Media Players / Portable TVs
- MP3 Players
- Portable Game Players
- Digital Camcorders

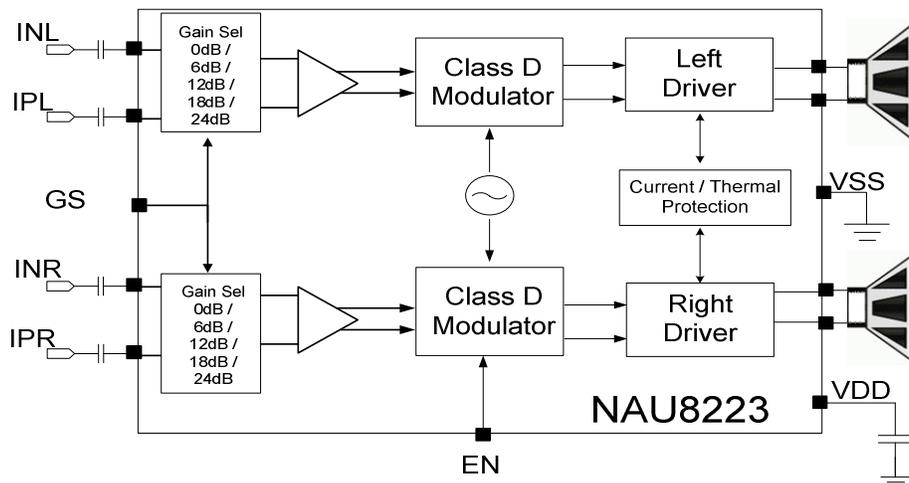
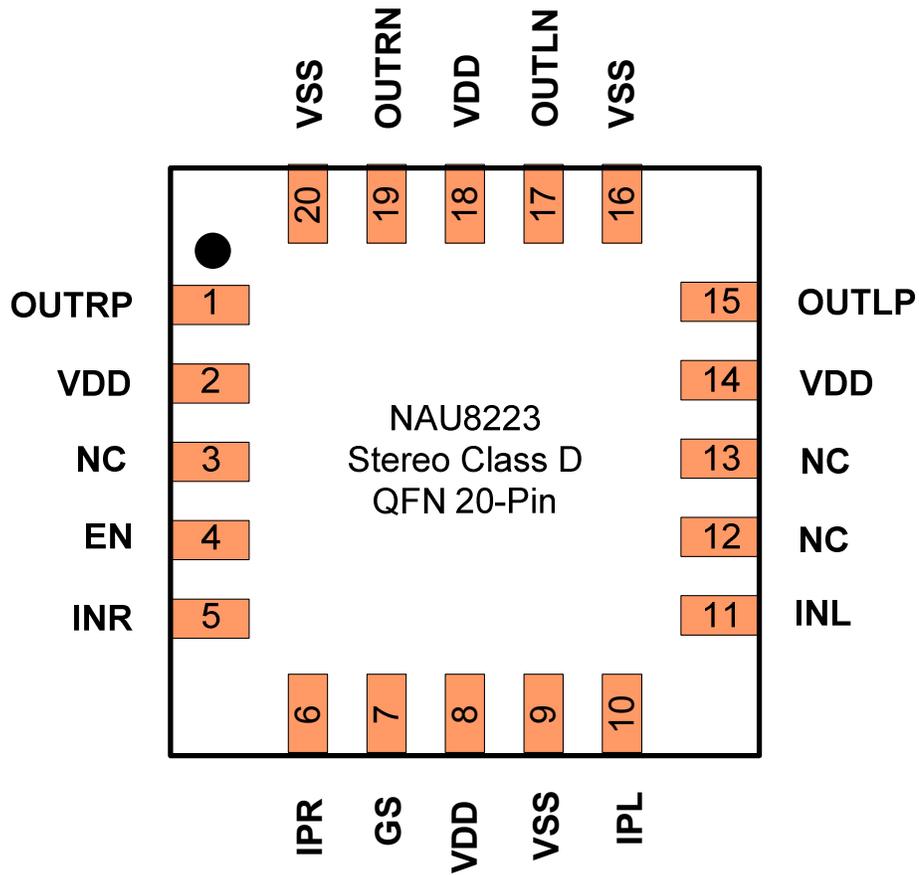


Figure 1: NAU8223Block Diagram

## 2 Pinout- QFN 20 (TOP VIEW)



Part Number	Dimension	Package	Package Material
NAU8223Y	4mm x 4mm	QFN-20	Pb-Free

### 3 Pin Descriptions

QFN	Name	Type	Functionality
1	OUTRP	Analog Output	Right Channel Positive BTL Output
2	VDD	Supply	Power Supply
3	NC	NC	No Connect
4	EN	Digital Input	Chip Enable (High = Enable; Low = PD)
5	INR	Analog Input	Right Channel Negative Input
6	IPR	Analog Input	Right Channel Positive Input
7	GS	Analog Input	5 Selectable Gain Setting (0dB / 6dB / 12dB / 18dB / 24dB)
8	VDD	Supply	Power Supply
9	VSS	Supply	Ground
10	IPL	Analog Input	Left Channel Positive Input
11	INL	Analog Input	Left Channel Negative Input
12	NC	NC	No Connect
13	NC	NC	No Connect
14	VDD	Supply	Power Supply
15	OUTLP	Analog Output	Left Channel Positive BTL Output
16	VSS	Supply	Ground
17	OUTLN	Analog Output	Left Channel Negative BTL Output
18	VDD	Supply	Power Supply
19	OUTRN	Analog Output	Right Channel Negative BTL Output
20	VSS	Supply	Ground
21	Ex-Pad	Analog Input	Thermal Tab (must be connected to VSS, QFN-20 package, only)

#### Notes

1. Pins designated as NC (Not Internally Connected) should be left as no-connection

**Table 1: NAU8223 Pin description**

## 4 Electrical Characteristics

Conditions: EN = VDD = 5V, VSS = 0V, Av = 12dB ZL = ∞, Bandwidth = 20Hz to 22kHz, TA = 25 °C

Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units	
<b>Power Delivered</b>							
Output Power (per channel)	P <sub>out</sub>	Z <sub>L</sub> = 4Ω + 33μH	VDD = 5.0V		3.1		W
		THD + N = 10%	VDD = 3.7V		1.57		
		Z <sub>L</sub> = 4Ω + 33μH	VDD = 5.0V		2.46		
		THD + N = 1%	VDD = 3.7V		1.26		
		Z <sub>L</sub> = 8Ω + 68μH	VDD = 5.0V		1.76		
		THD + N = 10%	VDD = 3.7V		0.95		
		Z <sub>L</sub> = 8Ω + 68μH	VDD = 5.0V		1.41		
		THD + N = 1%	VDD = 3.7V		0.76		

Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
<b>Chip Enable (EN)</b>						
Voltage Enable High	V <sub>EN_H</sub>	VDD = 2.5V to 5.5V	1.4			V
Voltage Enable Low	V <sub>EN_L</sub>	VDD = 2.5V to 5.5V			0.4	V
Input Leakage Current			-1		+1	μA
<b>Thermal and Current Protection</b>						
Thermal Shutdown Temperature				130		°C
Thermal Shutdown Hysteresis				15		°C
Short circuit Threshold	I <sub>LIMIT</sub>			2.1		A
<b>Gain Setting</b>						
Voltage Gain	A <sub>v</sub>	Tie GS to VSS		24		dB
		GS Connect VSS through 100k ± 5%		18		
		Tie GS pin to VDD		12		
		GS Connect VDD through 100k ± 5%		6		
		Floating Node		0		
Differential Input Resistance	R <sub>IN</sub>	A <sub>v</sub> = 24dB		35		kΩ
		A <sub>v</sub> = 18dB		70		
		A <sub>v</sub> = 12dB		140		
		A <sub>v</sub> = 6dB		280		
		A <sub>v</sub> = 0dB		558		

## Electrical Characteristics (continued)

Conditions: EN = VDD = 5V, VSS = 0V, Av = 12dB, ZL = ∞, Bandwidth = 20Hz to 22kHz, TA = 25 °C

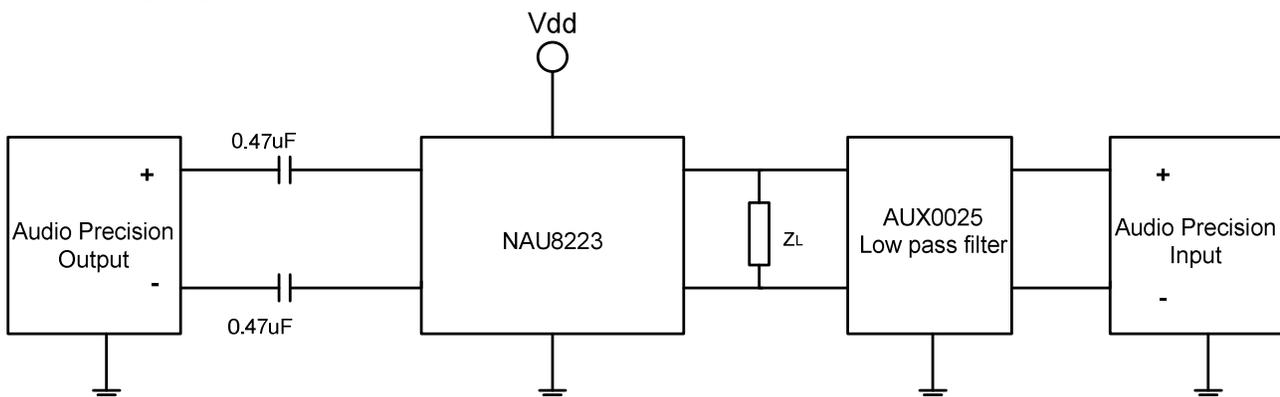
Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
<b>Normal Operation</b>						
Quiescent Current Consumption	I <sub>QUI</sub>	VDD = 3.7V		2.1		mA
		VDD = 5V		3.17		mA
Shut Down Current	I <sub>OFF</sub>	EN = 0		0.1		μA
Oscillator Frequency	f <sub>OSC</sub>			300		kHz
Efficiency	η			91		%
Start Up Time	T <sub>start</sub>			3.4		ms
Output Offset Voltage	V <sub>OS</sub>			±1	±4	mV
Common Mode Rejection Ratio	CMRR	f <sub>IN</sub> = 1kHz		80		dB
Click-and-Pop Suppression		Into Shutdown (Z <sub>L</sub> =8Ω) A Weighted		-72		dBV
Power Supply Rejection Ratio	DC PSRR	VDD = 2.5V to 5.5V		98		dB
	AC PSRR*	V <sub>RIPPLE</sub> = 0.2V <sub>pp</sub> @217Hz**		87		dB
		V <sub>RIPPLE</sub> = 0.2V <sub>pp</sub> @1KHz		74		
		V <sub>RIPPLE</sub> = 0.2V <sub>pp</sub> @10KHz		54		
Channel Crosstalk		f <sub>IN</sub> = 1kHz, Z <sub>L</sub> = 8Ω + 68μH		-101		dB

\*Measured with 0.1μF capacitor on V<sub>DD</sub> and Battery supply

\*\* Measured with 2.2μF input capacitor.

Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
<b>Noise Performance</b>						
		Av = 0dB (A-weighted)		20		μV <sub>RMS</sub>
		Av = 6dB (A-weighted)		21		
		Av = 12dB (A-weighted)		27		
		Av = 18dB (A-weighted)		36		
		Av = 24dB (A-weighted)		52		

The following setup is used to measure the above parameters



## Absolute Maximum Ratings

Condition	Min	Max	Units
Analog supply	-0.50	+5.50	V
Industrial operating temperature	-40	+85	°C
Storage temperature range	-65	+150	°C

*CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely influence product reliability and result in failures not covered by warranty.*

## Operating Conditions

Condition	Symbol	Min	Typical	Max	Units
Analog supply range	VDD	2.50	3.7	5.50	V
Ground	VSS		0		V

## 6 Special Feature Description

The NAU8223 offers excellent quantity performance as high efficiency, high output power and low quiescent current. It also provides the following special features.

### 6.1 Gain Setting

The NAU8223 has a GS pin, which can control five selectable gain settings (i.e. 0dB / 6dB / 12dB / 18dB / 24dB).

GS Pin Configuration	Internal Gain (dB)
GS tie to VSS	24
GS connect to VSS through 100kΩ ± 5% resistor	18
GS tie to VDD	12
GS connect to VDD through 100kΩ ± 5% resistor	6
Floating (open node)	0

### 6.2 Device Protection

The NAU8223 includes device protection for three operating scenarios. They are

1. Thermal Overload
2. Short circuit
3. Supply under voltage

#### 6.2.1 Thermal Overload Protection

When the device internal junction temperature reaches 130°C, the NAU8223 will disable the output drivers. When the device cools down and a safe operating temperature of 115°C has been reached for at least about 47ms, the output drivers will be enabled again.

#### 6.2.2 Short Circuit Protection

If a short circuit is detected on any of the pull-up or pull-down devices on the output drivers for at least 14μs, the output drivers will be disabled for 47ms. The output drivers will then be enabled again and check for the short circuit. If the short circuit is still present, the output drivers are disabled after 14μs. This cycle will continue until the short circuit is removed. The short circuit threshold is set at 2.1A.

#### 6.2.3 Supply under Voltage Protection

If the supply voltage drops under 2.1V, the output drivers will be disabled while the NAU8223 control circuitry still operates. This will avoid the battery supply to drag down too low before the host processor can safely shut down the devices on the system. If the supply drops further below 1.0V the internal power on reset activated and puts the entire device in power down state.

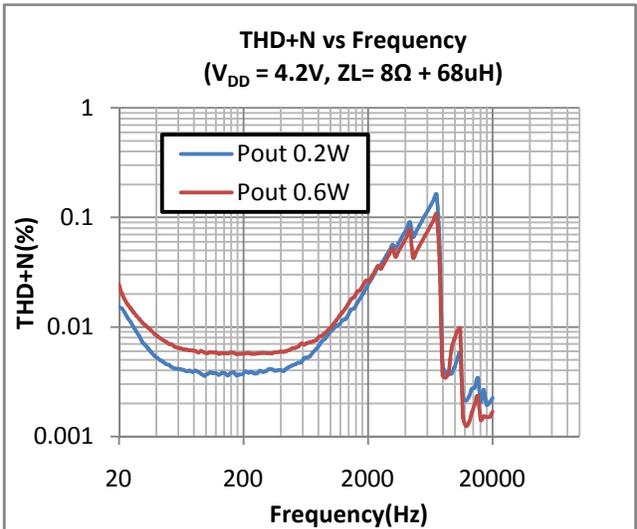
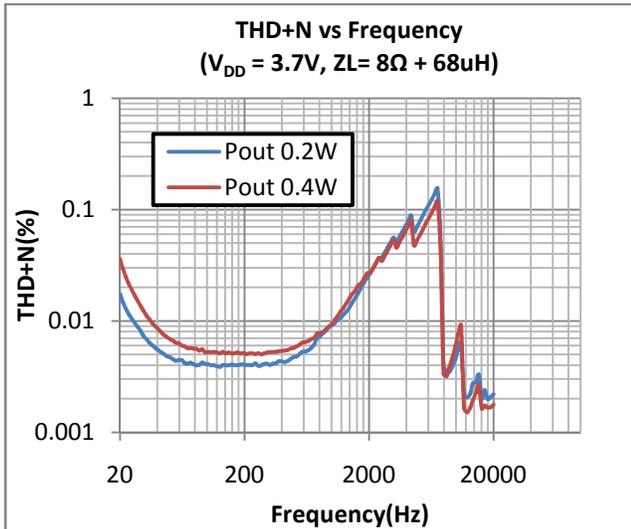
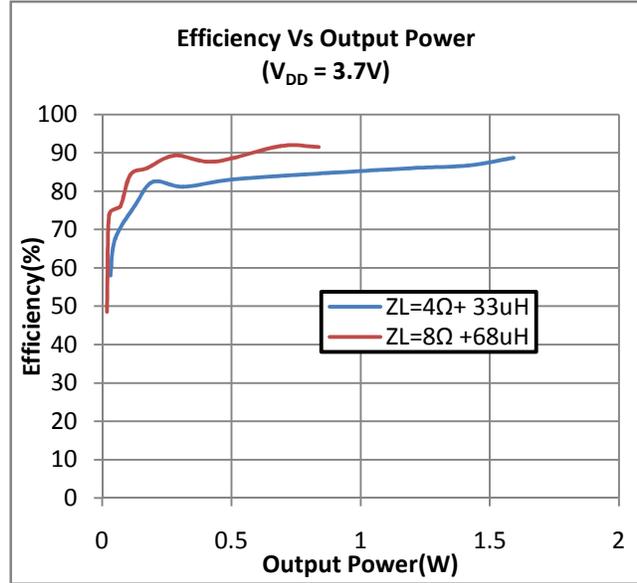
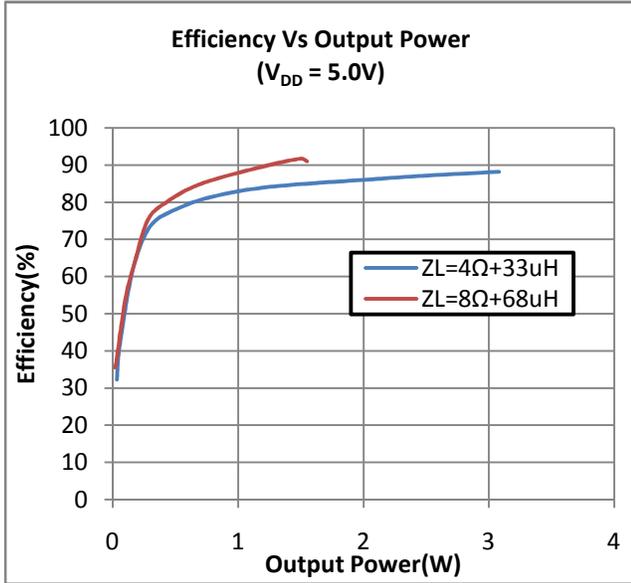
## 6.3 Power up and Power down Control

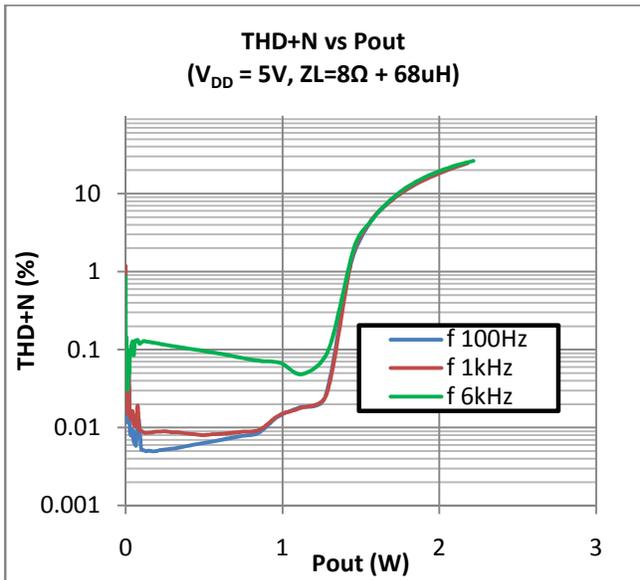
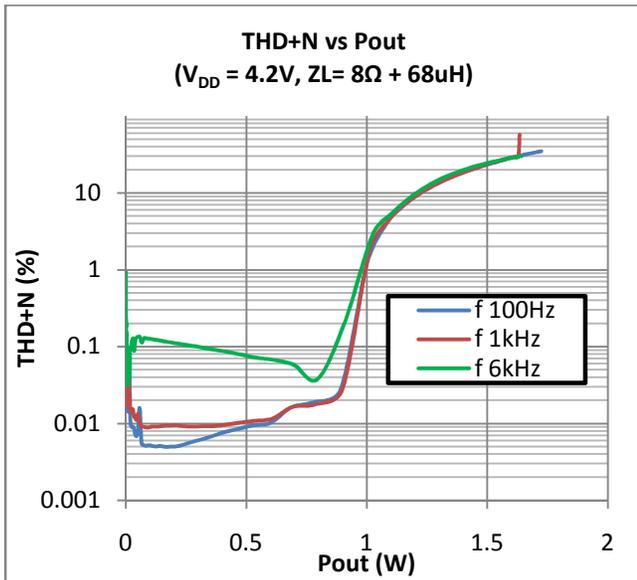
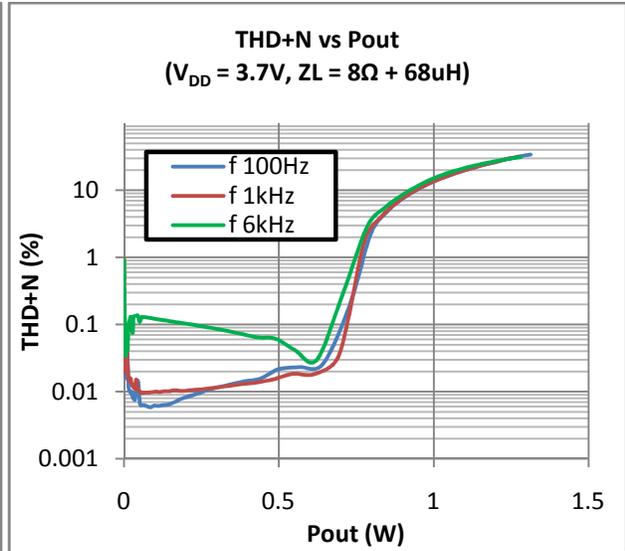
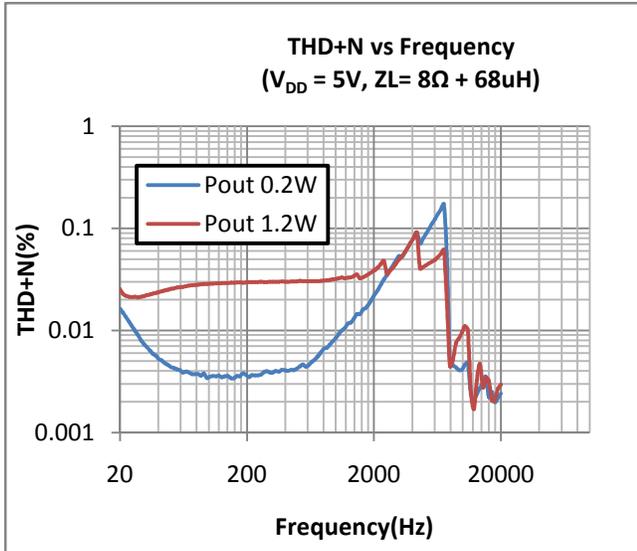
When the supply voltage ramps up, the internal power on reset circuit gets triggered. At this time all internal circuits will be set to power down state. The device can be enabled by setting the EN pin high. Upon setting the EN pin high, the device will go through an internal power up sequence in order to minimize 'pops' on the speaker output. The complete power up sequence will take about 3.4ms. The device will power down in about 30 $\mu$ s, when the EN pin is set low.

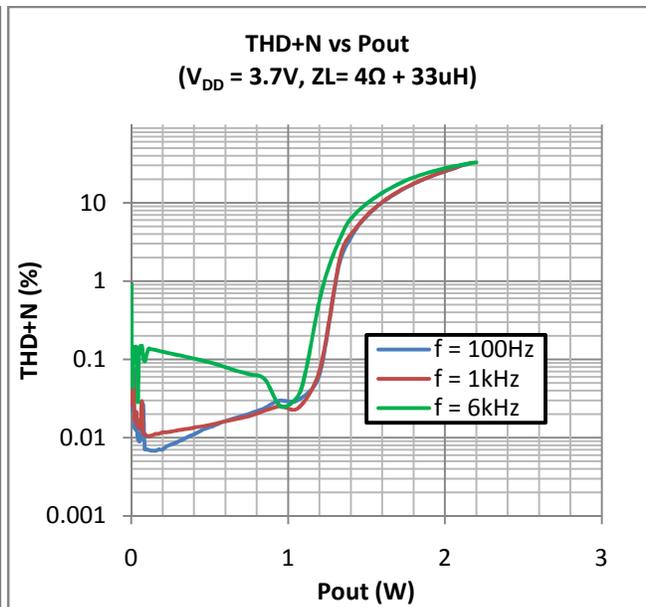
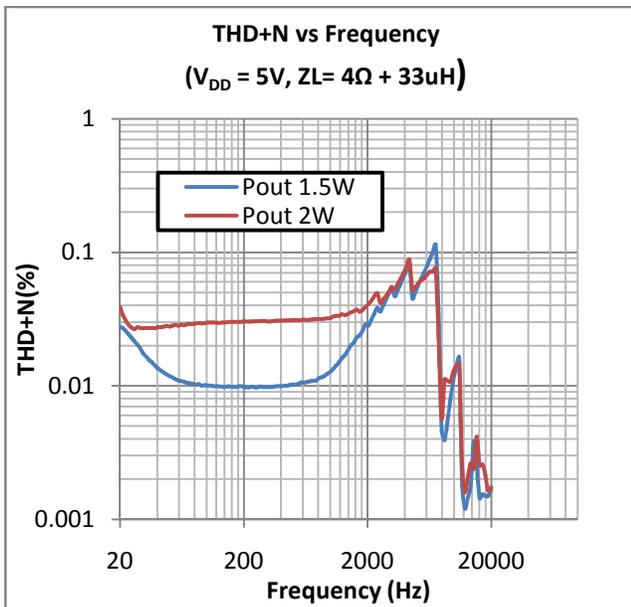
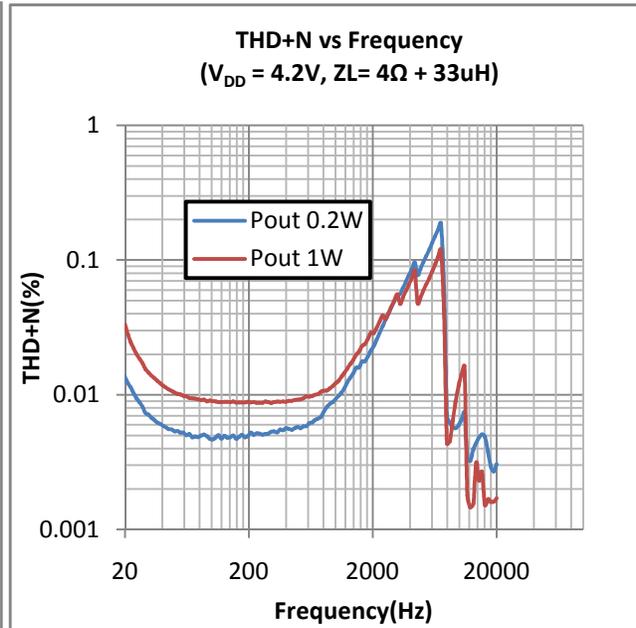
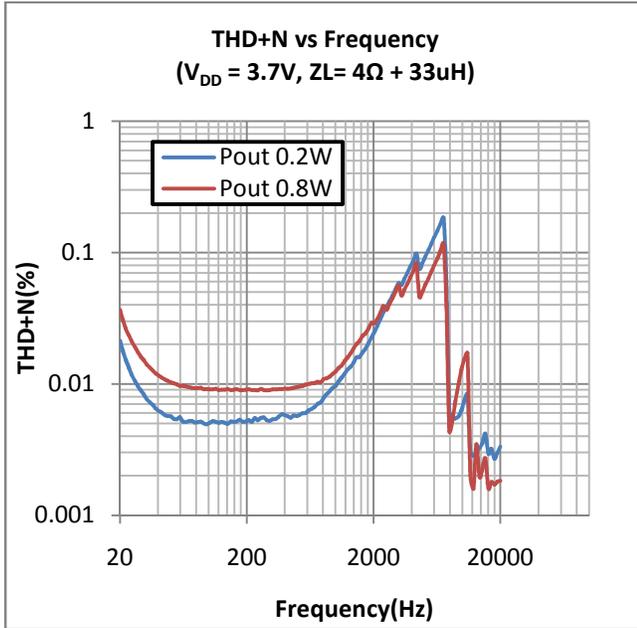
It is important to keep the input signal at zero amplitude or enable the mute condition in order to minimize the 'pops' when the EN pin is toggled.

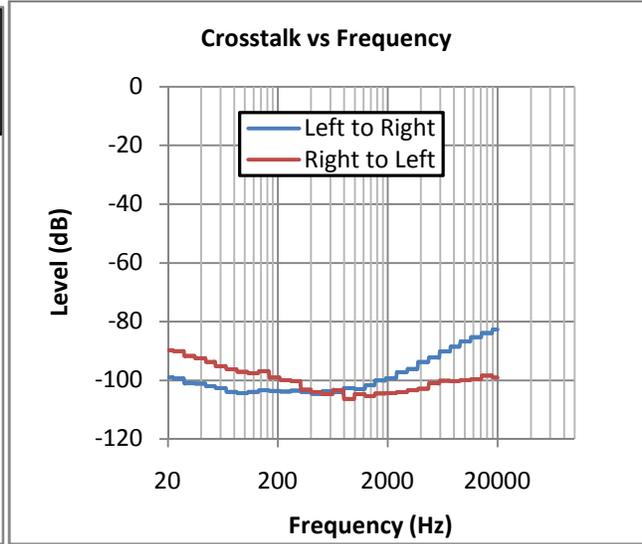
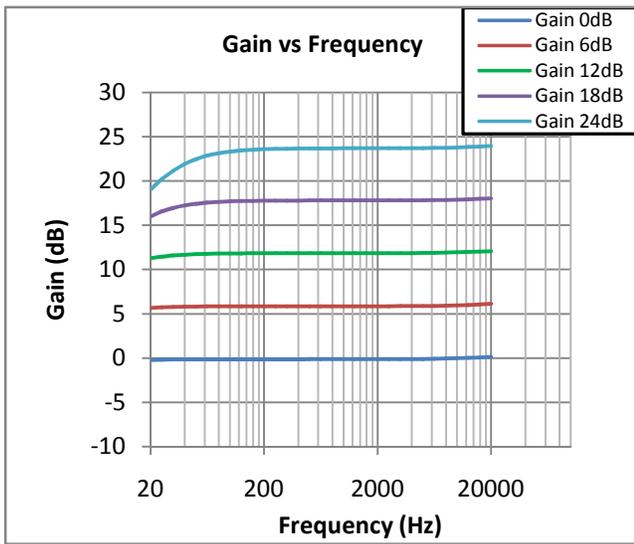
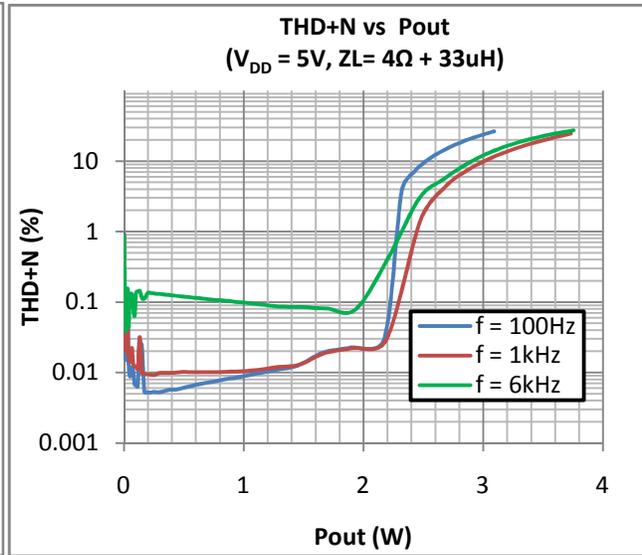
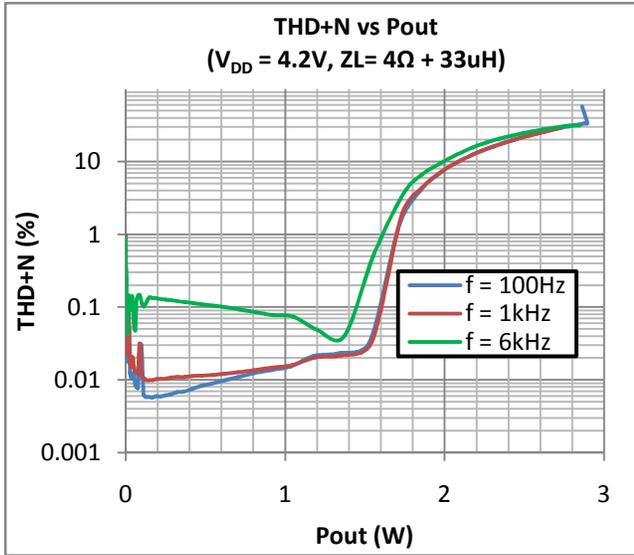
## 7 Typical Operating Characteristics

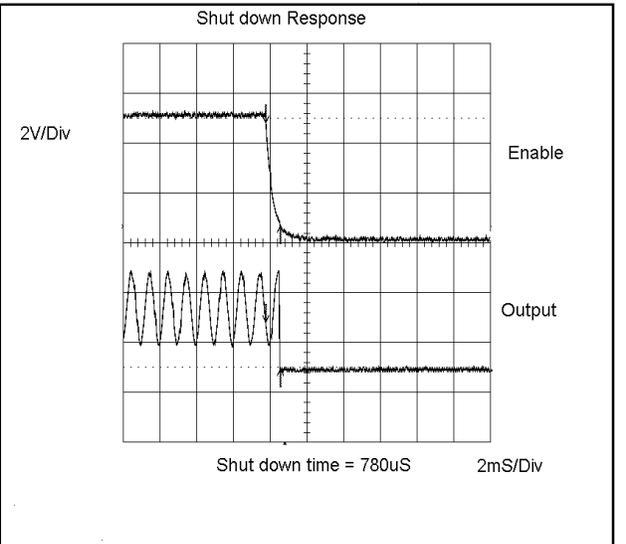
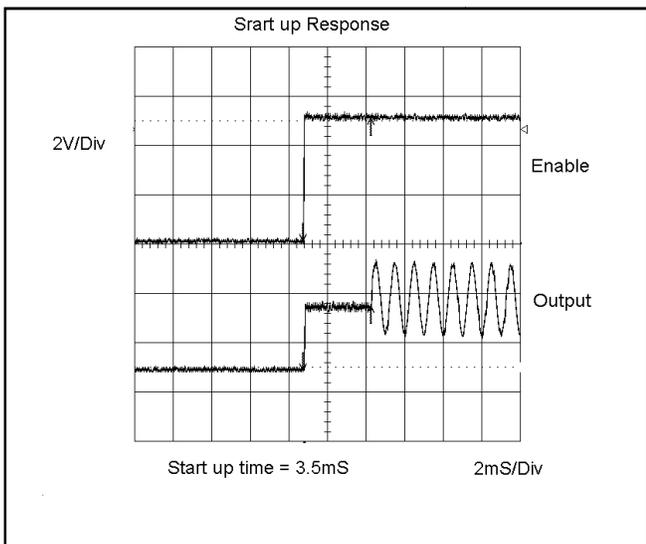
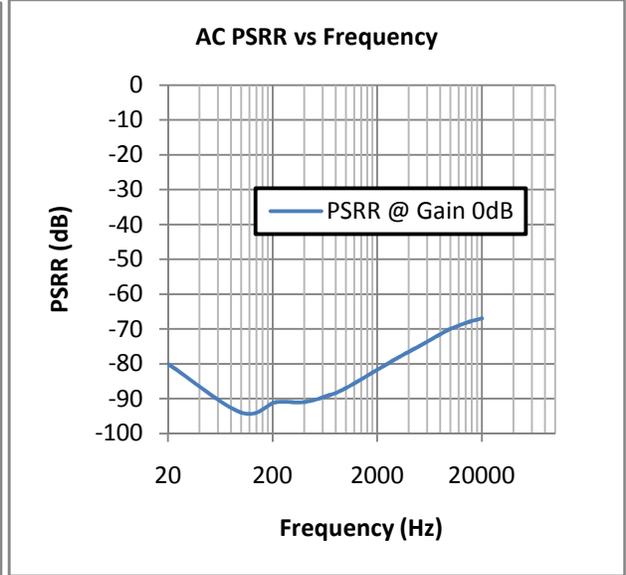
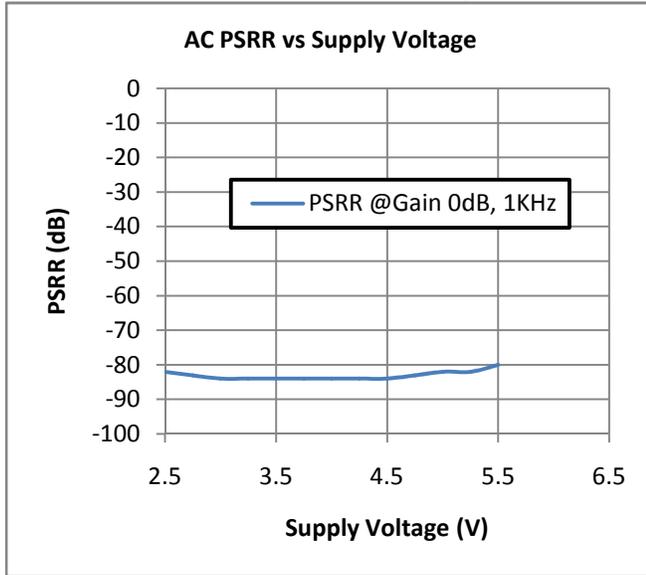
Conditions:  $V_{DD} = 5V$ ,  $V_{SS} = 0V$ ,  $A_v = 12dB$ ,  $Z_L = \infty$ , Bandwidth = 20Hz to 22kHz,  $T_A = 25^\circ C$ , unless otherwise noted

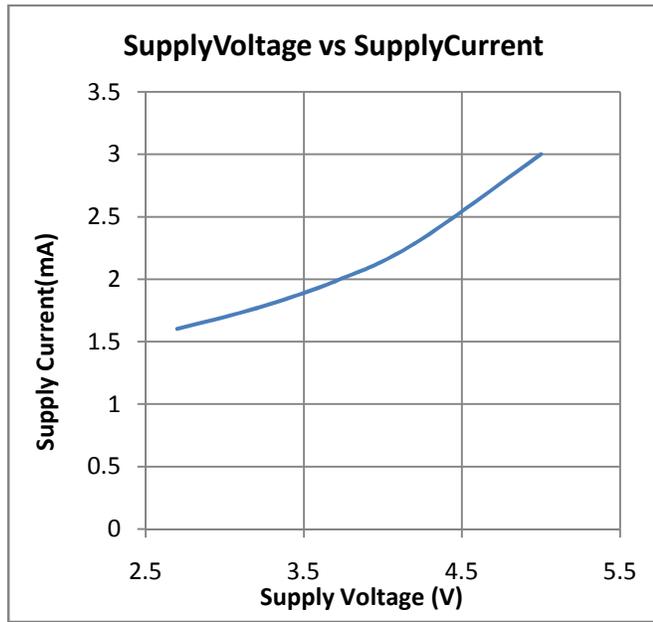






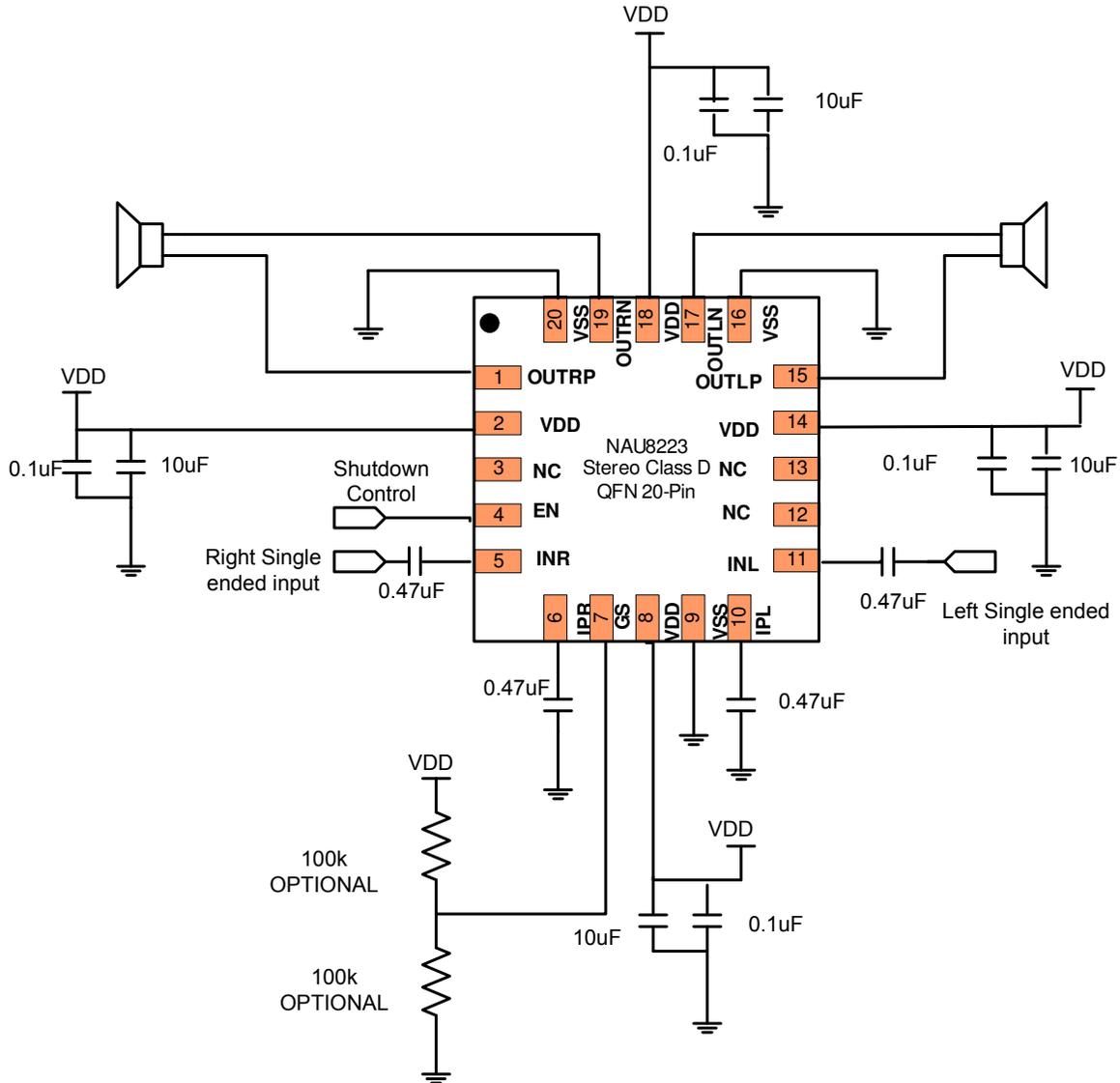






## 8 Application Information

### 8.1 Application diagram



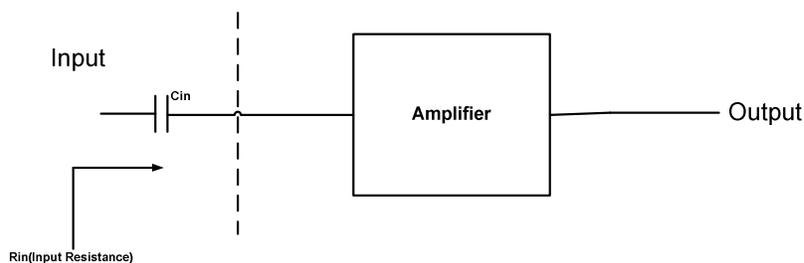
**P.S.** GS Pin – The 100kΩ resistors are optional. GS can be floating for internal gain setting = 0dB. Please refer Section 2.1 (Gain Setting) for the detailed explanation.

## 8.2 Component selection

### Coupling Capacitors

An ac coupling capacitor ( $C_{in}$ ) is used to block the dc content from the input source. The input resistance of the amplifier ( $R_{in}$ ) together with the  $C_{in}$  will act as a high pass filter. So depending on the required cut off frequency the  $C_{in}$  can be calculated by using the following formula

$C_{in} = 1/2\pi R_{in}f_c$  Where  $f_c$  is the desired cut off frequency of the High pass filter.

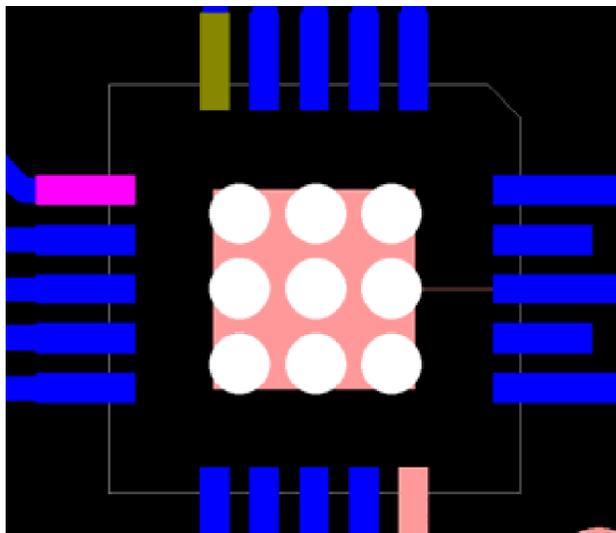


### Bypass Capacitors

Bypass capacitors are required to remove the ac ripple on the VDD pins. The value of these capacitors depends on the length of the VDD trace. In most cases, 10 $\mu$ F and 0.1 $\mu$ F are enough to get the good performance.

## 8.3 Layout considerations

The NAU8223 QFN package uses an exposed pad on the bottom side of the package to dissipate excess power from the output drivers. This pad must be soldered carefully to the PCB for proper operation of the NAU8223. This pad is internally connected to Vss. A typical layout is shown below.

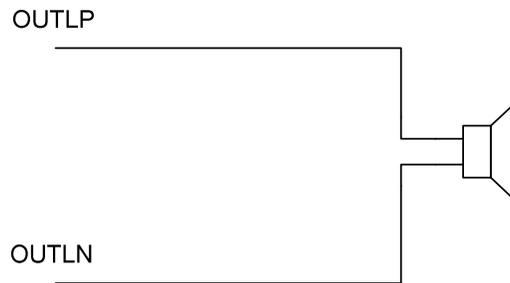


The PCB has to be designed in such a manner that it should have nine vias in 3x3 grid under NAU8223. The vias should have hole size of 12mil and a spacing of 30mils. The pad size of the vias is 24mils. The vias on the top side of the board should be connected with a copper pour that has an area of 2mm x 2mm, centered underneath the NAU8223. The nine vias should connect to copper pour area on the bottom of the PCB. It is preferred to pour the complete bottom side of the board with Vss.

Also good PCB layout and grounding techniques are essential to get the good audio performance. It is better to use low resistance traces as these devices are driving low impedance loads. The resistance of the traces has a significant effect on the output power delivered to the load. In order to dissipate more heat, use wide traces for the power and ground lines.

## 8.4 Class D without filter

The NAU8223 is designed for use without any filter on the output line. That means the outputs can be directly connected to the speaker in the simplest configuration. This type of filter less design is suitable for portable applications where the speaker is very close to the amplifier. In other words, this is preferable in applications where the length of the traces between the speaker and amplifier is short. The following diagram shows this simple configuration.



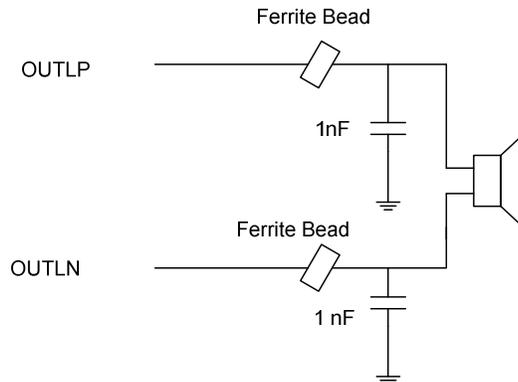
**NAU8223 outputs connected to speaker without filter circuit**

## 8.5 Class D with filter

In some applications, the shorter trace lengths are not possible because of speaker size limitations and other layout reasons. In these applications, the long traces will cause EMI issues. There are two types of filter circuits available to reduce the EMI effects. These are ferrite bead and LC filters.

### Ferrite Bead filter

The ferrite bead filters are used to reduce the high frequency emissions. The typical circuit diagram is shown in the figure.

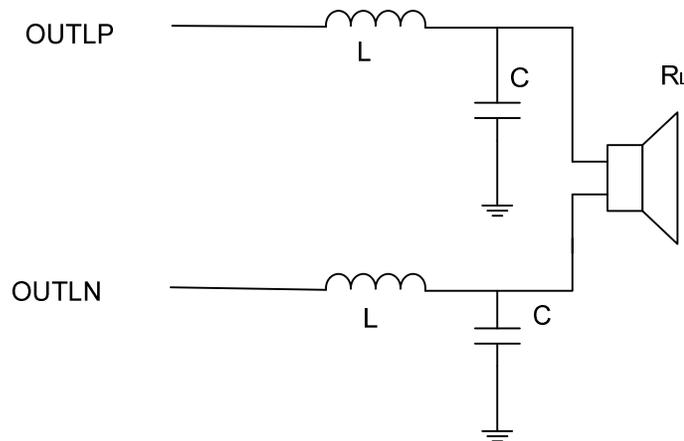


**NAU8223 outputs connected to speaker with Ferrite Bead filter**

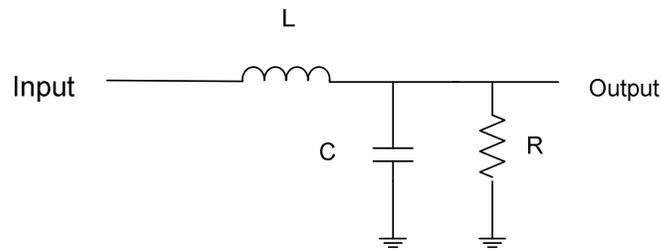
The characteristic of ferrite bead is such that it offers higher impedance at high frequencies. For better EMI performance select ferrite bead which offers highest impedance at high frequencies, so that it will attenuate the signals at higher frequencies. Usually the ferrite beads have low impedance in the audio range, so it will act as a pass through filter in the audio frequency range.

## LC filter

The LC filter is used to suppress the low frequency emissions. The following diagram shows the NAU8223 outputs connected to the speaker with LC filter circuit.  $R_L$  is the resistance of the speaker coil.



**NAU8223 outputs connected to speaker with LC filter**



## Standard Low pass LCR filter

The following are the equations for the critically damped ( $\zeta = 0.707$ ) standard low pass LCR filter

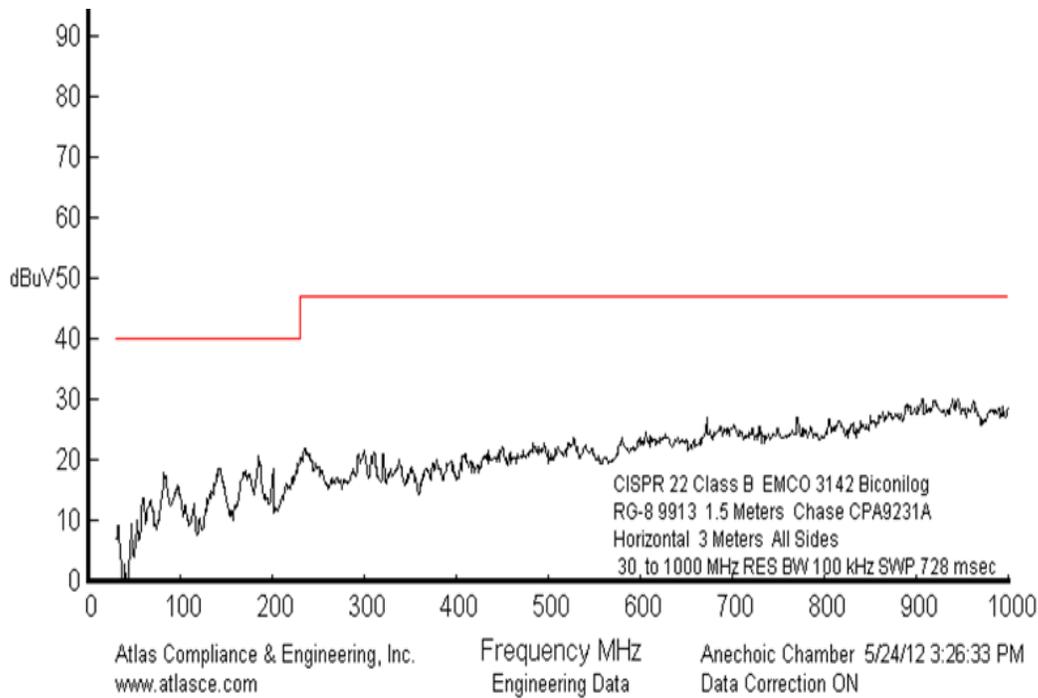
$$2\pi f_c = \frac{1}{\sqrt{LC}} \quad f_c \text{ is the cutoff frequency}$$

$$\zeta = 0.707 = \frac{1}{2R} * \sqrt{\frac{L}{C}}$$

The L and C values for differential configuration can be calculated by duplicating the single ended configuration values and substituting  $R_L = 2R$ .

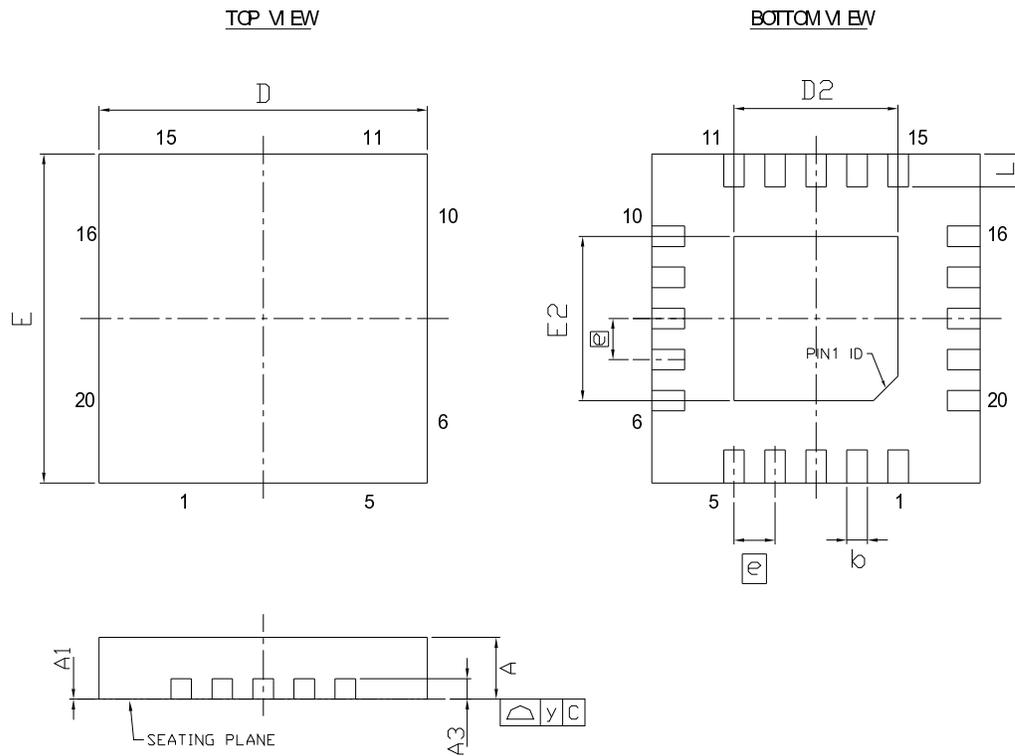
## 8.6 NAU8223 EMI performance

The NAU8223 includes a spread spectrum oscillator for reduced EMI. The PWM oscillator frequency typically sweeps in a range of 300 kHz +/- 15 kHz in order to spread the energy of the PWM pulses over a larger frequency band. In addition, slew rate control on the output drivers allows the application of 'filter less' loads, while suppressing EMI at high frequencies. The below graph shows the EMI performance of NAU8223 with ferrite beads and speaker cable length of 30cm.



## 9 Package Dimensions

### 9.1 QFN20L 4X4 MM<sup>2</sup>, Pitch:0.50 MM



Controlling Dimension :Millimeters

SYMBOL	DIMENSION (MM)			DIMENSION (Inch)		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.70	0.75	0.80	0.02756	0.02953	0.03150
A1	0	0.02	0.05	0	0.0079	0.00197
A3	0.203 REF			0.0079 REF		
b	0.18	0.25	0.30	0.00709	0.00984	0.01181
D	3.90	4.00	4.10	0.1535	0.1575	0.1614
D2	1.90	2.00	2.10	0.0748	0.0787	0.0827
E	3.90	4.00	4.10	0.1535	0.1575	0.1614
E2	1.90	2.00	2.10	0.0748	0.0787	0.0827
e	0.50 BSC			0.01969 BSC		
L	0.30	0.40	0.50	0.01181	0.01574	0.01969
y	0.08			0.00315		

Note:D2,E2 by die size difference .

## 10 Ordering Information

Nuvoton Part Number Description

NAU8223 YG

**Package Material:**

**G** = Pb-free Package

**Package Type:**

**Y** = 20-Pin QFN Package

### Version History

VERSION	DATE	PAGE	DESCRIPTION
Rev1.0	March, 2012	P.8, P.9	Preliminary Revision Update the typical characteristic
Rev1.1	March, 2012	P.2, P.10	Update the Pin No. Add the application diagrams
Rev1.2	May, 2012	NA	Update the Electrical Characteristic
Rev1.3	July, 2012	P.4, P.5, P.10-P.18	Added Application information section Added/Modified Typical operating Characteristics Updated Electrical Characteristics

Table 1: Version History

### Important Notice

Nuvoton products are not designed, intended, authorized or warranted for use as components in systems or equipment intended for surgical implantation, atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, or for other applications intended to support or sustain life. Furthermore, Nuvoton products are not intended for applications wherein failure of Nuvoton products could result or lead to a situation wherein personal injury, death or severe property or environmental damage could occur.

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